# HLMP-ELxx, HLMP-EHxx, HLMP-EDxx Precision Optical Performance AllnGaP II LED Lamps 

## Data Sheet



## Description

Precision Optical Performance AllnGaP II (aluminum indium gallium phosphide) LEDs offer superior light output for excellent readability in sunlight and dependable performance. The AllnGaP II technology provides extremely stable light output over long periods of time.

These LED lamps are untinted, nondiffused, $\mathrm{T}-1^{3 / 4} 4$ packages incorporating second generation optics which produce well defined radiation patterns at specific viewing cone angles.

These lamps are made with an advanced optical grade epoxy offering superior high temperature and high moisture resistance performance in outdoor signal and sign applications. The maximum LED junction temperature limit of $+130^{\circ} \mathrm{C}$ enables high temperature operation in bright sunlight conditions. The epoxy contains both uv-a and uv-b inhibitors to reduce the effects of long term exposure to direct sunlight.

## Benefits

- Viewing angles match traffic management requirements
- Colors meet automotive and traffic signal specifications
- Superior light output performance in outdoor environments
- Suitable for autoinsertion into PC boards


## Features

- Well defined spatial radiation patterns
- Viewing angles: $15^{\circ}, 23^{\circ}, 30^{\circ}$
- High luminous output
- Colors:

592 nm Amber
617 nm Reddish-Orange
630 nm Red

- High operating temperature:
$\mathrm{T}_{\text {JLED }}=+130^{\circ} \mathrm{C}$
- Superior resistance to moisture


## Applications

- Traffic management:

Traffic signals
Work zone warning lights
Variable message signs

- Commercial outdoor advertising:

Signs
Marquees

- Automotive:

Exterior and interior lights

## $\mathrm{T}-13 / 4(5 \mathrm{~mm})$ Precision Optical Performance AllnGaP II LED Lamps

## Selection Guide

| Typical Viewing Angle 2 $\theta^{1 / 2}$ (Deg.) ${ }^{[2]}$ | Color and <br> Dominant <br> Wavelength <br> ( nm ), Typ. ${ }^{11]}$ | Lamps Without Standoffs (Outline Drawing A) | Lamps With Standoffs (Outline Drawing B) | Luminous <br> Intensity Iv (mcd) ${ }^{[3,4,5]}$ <br> @ $1(f)=20 \mathrm{~mA}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. |
| $15^{\circ}$ | Amber 592 | HLMP-EL16-S0000 | HLMP-EL18-S0000 | 1900 | - |
|  |  | HLMP-EL16-TW000 |  | 2500 | 7200 |
|  |  | HLMP-EL16-UX000 | HLMP-EL18-UX000 | 3200 | 9300 |
|  |  | HLMP-EL16-UXR00 |  | 3200 | 9300 |
|  |  | HLMP-EL16-VW000 |  | 4200 | 7200 |
|  |  | HLMP-EL16-VX400 |  | 7200 | 21000 |
|  |  | HLMP-EL16-VY000 | HLMP-EL18-VY000 | 4200 | 12000 |
|  |  | HLMP-EL16-VYR00 | HLMP-EL18-VYR00 | 4200 | 12000 |
|  |  | HLMP-EL16-VYK00 |  | 4200 | 12000 |
|  |  | HLMP-EL16-VYS00 | HLMP-EL18-VYS00 | 4200 | 12000 |
|  | Red-Orange 617 | HLMP-EH16-TW000 |  | 2500 | 7200 |
|  |  | HLMP-EH16-UX000 | HLMP-EH18-UX000 | 3200 | 9300 |
|  |  | HLMP-EH16-VXODD |  | 4200 | 9300 |
|  | Red 630 | HLMP-ED16-S0000 | HLMP-ED18-S0000 | 1900 | - |
|  |  | HLMP-ED16-TW000 | HLMP-ED18-TW000 | 2500 | 7200 |
|  |  |  | HLMP-ED18-TWT00 | 2500 | 7200 |
|  |  | HLMP-ED16-UX000 | HLMP-ED18-UX000 | 3200 | 9300 |
|  |  | HLMP-ED16-UXT00 | HLMP-ED18-UXT00 | 3200 | 9300 |
|  |  | HLMP-ED16-VX000 | HLMP-ED18-VX000 | 4200 | 9300 |

## Notes:

1. Dominant Wavelength, $\lambda_{d}$, is derived from the CIE Chromaticity Diagram and represents the color of the lamp.
2. $\theta_{1 / 2}$ is the off-axis angle where the luminous intensity is one half the on-axis intensity.
3. The luminous intensity is measured on the mechanical axis of the lamp package.
4. The optical axis is closely aligned with the package mechanical axis.
5. Tolerance for each intensity bin limit is $\pm 15 \%$.

## $\mathrm{T}-13 / 4(5 \mathrm{~mm})$ Precision Optical Performance AllnGaP II Led Lamps (Continued)

## Selection Guide

| Typical Viewing Angle 2 $\theta^{1 / 2}$ <br> (Deg.) ${ }^{[2]}$ | Color and Dominant Wavelength ( nm ), Typ. ${ }^{[1]}$ | Lamps Without Standoffs (Outline Drawing A) | Lamps With Standoffs (Outline Drawing B) | Luminous <br> Intensity Iv (mcd) ${ }^{[3,4,5]}$ <br> @ $1(f)=20 \mathrm{~mA}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. |
| $23^{\circ}$ | Amber 592 | HLMP-EL25-Q0000 | HLMP-EL27-Q0000 | 1150 | - |
|  |  |  | HLMP-EL27-QTR00 | 1150 | 3200 |
|  |  | HLMP-EL25-RU000 | HLMP-EL27-RU000 | 1500 | 4200 |
|  |  | HLMP-EL25-SU000 |  | 1900 | 4200 |
|  |  | HLMP-EL25-SVK00 |  | 1900 | 5500 |
|  |  | HLMP-EL25-SV000 | HLMP-EL27-SV000 | 1900 | 5500 |
|  |  | HLMP-EL25-SVR00 | HLMP-EL27-SVR00 | 1900 | 5500 |
|  |  | HLMP-EL25-TW000 | HLMP-EL27-TW000 | 2500 | 7200 |
|  |  | HLMP-EL25-TWR00 | HLMP-EL27-TWR00 | 2500 | 7200 |
|  |  | HLMP-EL25-TWK00 |  | 2500 | 7200 |
|  |  | HLMP-EL25-TWS00 |  | 2500 | 7200 |
|  |  | HLMP-EL25-UX000 |  | 3200 | 9300 |
|  | Red-Orange 617 | HLMP-EH25-QT000 | HLMP-EH27-QT000 | 1150 | 3200 |
|  |  | HLMP-EH25-SV000 |  | 1900 | 5500 |
|  |  | HLMP-EH25-TW000 | HLMP-EH27-TW000 | 2500 | 7200 |
|  | Red 630 | HLMP-ED25-RU000 |  | 3200 | 9300 |
|  |  | HLMP-ED25-RUT00 |  | 3200 | 9300 |
|  |  | HLMP-ED25-SV000 | HLMP-ED27-SV000 | 1900 | 5500 |
|  |  | HLMP-ED25-TW000 | HLMP-ED27-TW000 | 2500 | 7200 |
|  |  | HLMP-ED25-TWT00 | HLMP-ED27-TWT00 | 2500 | 7200 |

## Notes:

1. Dominant Wavelength, $\lambda_{d}$, is derived from the CIE Chromaticity Diagram and represents the color of the lamp.
2. $\theta_{1 / 2}$ is the off-axis angle where the luminous intensity is one half the on-axis intensity.
3. The luminous intensity is measured on the mechanical axis of the lamp package.
4. The optical axis is closely aligned with the package mechanical axis.
5. Tolerance for each intensity bin limit is $\pm 15 \%$.

## $\mathrm{T}-13 / 4(5 \mathrm{~mm})$ Precision Optical Performance AllnGaP II Led Lamps (Continued)

## Selection Guide

| Typical Viewing Angle $2 \theta^{1 / 2}$ (Deg.) ${ }^{[2]}$ | Color and <br> Dominant <br> Wavelength <br> (nm), Typ. ${ }^{[1]}$ | Lamps Without Standoffs (Outline Drawing A) | Lamps With Standoffs (Outline Drawing B) | Luminous <br> Intensity Iv (mcd) ${ }^{[3,4,5]}$ <br> @l(f) $=\mathbf{2 0} \mathrm{mA}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. |
| $30^{\circ}$ | Amber 592 | HLMP-EL31-P0000 |  | 880 | - |
|  |  | HLMP-EL31-QT000 | HLMP-EL33-QT000 | 1150 | 3200 |
|  |  | HLMP-EL31-QTR00 |  | 1150 | 3200 |
|  |  | HLMP-EL31-SV000 | HLMP-EL33-SV000 | 1900 | 5500 |
|  |  | HLMP-EL31-SVK00 |  | 1900 | 5500 |
|  |  | HLMP-EL31-SVR00 | HLMP-EL33-SVR00 | 1900 | 5500 |
|  |  | HLMP-EL31-STR00 |  | 1900 | 3200 |
|  |  | HLMP-EL31-SUK00 |  | 1900 | 4200 |
|  |  | HLMP-EL31-SUS00 |  | 1900 | 4200 |
|  |  | HLMP-EL31-SUR00 |  | 1900 | 4200 |
|  |  | HLMP-EL31-SVK00 |  | 1900 | 5500 |
|  |  | HLMP-EL31-SVS00 |  | 1900 | 5500 |
|  | Red-Orange 617 | HLMP-EH31-QT000 |  | 1150 | 3200 |
|  |  |  | HLMP-EH33-RU000 | 1500 | 4200 |
|  |  | HLMP-EH31-SV000 | HLMP-EH33-SV000 | 1900 | 5500 |
|  | Red 630 | HLMP-ED31-Q0000 | HLMP-ED33-Q0000 | 1150 | - |
|  |  | HLMP-ED31-QTT00 |  | 1150 | 3200 |
|  |  | HLMP-ED31-ST000 |  | 1900 | 3200 |
|  |  | HLMP-ED31-SUT00 |  | 1900 | 4200 |
|  |  | HLMP-ED31-RU000 |  | 1500 | 4200 |
|  |  | HLMP-ED31-RUT00 | HLMP-ED33-RUT00 | 1500 | 4200 |
|  |  | HLMP-ED31-SV000 | HLMP-ED33-SV000 | 1900 | 5500 |
|  |  | HLMP-ED31-SVT00 | HLMP-ED33-SVT00 | 1900 | 5500 |

## Notes:

1. Dominant Wavelength, $\lambda_{d}$, is derived from the CIE Chromaticity Diagram and represents the color of the lamp.
2. $\theta_{1 / 2}$ is the off-axis angle where the luminous intensity is one half the on-axis intensity.
3. The luminous intensity is measured on the mechanical axis of the lamp package.
4. The optical axis is closely aligned with the package mechanical axis.
5. Tolerance for each intensity bin limit is $\pm 15 \%$.

## Part Numbering System



[^0]
## Package Dimensions


Absolute Maximum Ratings at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
DC Forward Current ${ }^{[1,2,3]}$...................................................................... 50 mA
Peak Pulsed Forward Current ${ }^{[2,3]} \ldots . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . ~ 100 ~ m A ~$
Average Forward Current ........................................................................... 30 mA

LED Junction Temperature............................................................................. $130^{\circ} \mathrm{C}$
Operating Temperature ............................................................. $40^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$
Storage Temperature ................................................................ $-40^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$

Notes:

1. Derate linearly as shown in Figure 4.
2. For long term performance with minimal light output degradation, drive currents between 10 mA and 30 mA are recommended. For more information on recommended drive conditions, please refer to Application Brief I-024 (5966-3087E).
3. Please contact your sales representative about operating currents below 10 mA .

Electrical/Optical Characteristics at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Parameter | Symbol | Min. | Typ. | Max. | Units | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Forward Voltage |  |  |  |  |  | $\mathrm{I}_{\mathrm{F}}=20 \mathrm{~mA}$ |
| Amber ( $\lambda_{d}=592 \mathrm{~nm}$ ) |  |  | 2.3 |  |  |  |
| Red-Orange ( $\lambda_{\mathrm{d}}=617 \mathrm{~nm}$ ) | $\mathrm{V}_{\mathrm{F}}$ |  | 2.35 | $2.6{ }^{[1]}$ | V |  |
| $\operatorname{Red}\left(\lambda_{d}=630 \mathrm{~nm}\right)$ |  |  | 2.4 |  |  |  |
| Reverse Voltage | $\mathrm{V}_{\mathrm{R}}$ | 5 | 20 |  | V | $\mathrm{I}_{\mathrm{R}}=100 \mu \mathrm{~A}$ |
| Peak Wavelength |  |  |  |  |  | Peak of Wavelength of |
| Amber |  |  | 594 |  |  | Spectral Distribution |
| Red-Orange | $\lambda_{\text {PEAK }}$ |  | 623 |  | nm | at $\mathrm{I}_{\mathrm{F}}=20 \mathrm{~mA}$ |
| Red |  |  | 639 |  |  |  |
| Spectral Halfwidth | $\Delta \lambda_{1 / 2}$ |  | 17 |  | nm | Wavelength Width at Spectral Distribution $1 / 2$ Power Point at $\mathrm{I}_{\mathrm{F}}=20 \mathrm{~mA}$ |
| Speed of Response | $\tau_{\text {s }}$ |  | 20 |  | ns | Exponential Time Constant, $\mathrm{e}^{-\mathrm{t} / \mathrm{t}_{\mathrm{s}}}$ |
| Capacitance | C |  | 40 |  | pF | $\mathrm{V}_{\mathrm{F}}=0, \mathrm{f}=1 \mathrm{MHz}$ |
| Thermal Resistance | R $\Theta_{J-P I N}$ |  | 240 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ | LED Junction-to-Cathode Lead |
| Luminous Efficacy ${ }^{\text {[2] }}$ |  |  |  |  |  | Emitted Luminous |
| Amber |  |  | 500 |  |  | Power/Emitted Radiant Power |
| Red-Orange | $\eta_{v}$ |  | 235 |  | Im/W | at $\mathrm{I}_{\mathrm{f}}=20 \mathrm{~mA}$ |
| Red |  |  | 155 |  |  |  |
| Luminous Flux | PV |  | 1000 |  | mlm | $\mathrm{IF}=20 \mathrm{~mA}$ |
| Luminous Efficiency ${ }^{\text {[3] }}$ | $\eta_{e}$ |  |  |  |  | Emitted |
| Amber |  |  | 22 |  |  | Luminous Flux/ |
| Red-Orange |  |  | 22 |  | Im/W | Electrical Power |
| Red |  |  | 21 |  |  |  |

## Notes:

1. For options $-x x R x x,-x x S x x,-x x T x x,-x x U x x,-x x W x x,-x x Y x x$, max forward voltage ( Vf ) is 2.6 V . Refer to Vf bin table.
2. The radiant intensity, $\mathrm{I}_{\mathrm{e}}$, in watts per steradian, may be found from the equation $\mathrm{l}_{\mathrm{e}}=\mathrm{I}_{\mathrm{v}} / \eta_{\mathrm{v}}$, where $\mathrm{I}_{\mathrm{v}}$ is the luminous intensity in candelas and $\eta_{\mathrm{v}}$ is the luminous efficacy in lumens/watt.
3. $\eta_{e}=\varphi_{V} / I_{F} \times V_{F}$ where $\varphi_{V}$ is the emitted luminous flux, $I_{F}$ is electrical forward current and $V_{F}$ is the forward voltage.


Figure 1. Relative Intensity vs. Peak Wavelength.


Figure 2a. Forward Current vs. Forward Voltage for Option -xxRxx, -xxSxx, -xxTxx, -xxUxx, -xxWxx and -xxYxx.



Figure 5. Representative Spatial Radiation Pattern for $15^{\circ}$ Viewing Angle Lamps.


Figure 6. Representative Spatial Radiation Pattern for $23^{\circ}$ Viewing Angle Lamps.


Figure 7. Representative Spatial Radiation Pattern for $30^{\circ}$ Viewing Angle Lamps.


Figure 8. Relative light output vs. junction temperature

| Intensity Bin Limits <br> $(\mathrm{mcd}$ at 20 mA) $)$ |  |  |
| :--- | :--- | :--- |
| Bin Name | Min. | Max. |
| P | 880 | 1150 |
| Q | 1150 | 1500 |
| $R$ | 1500 | 1900 |
| $S$ | 1900 | 2500 |
| $T$ | 2500 | 3200 |
| $U$ | 3200 | 4200 |
| $V$ | 4200 | 5500 |
| $W$ | 5500 | 7200 |
| $X$ | 7200 | 9300 |
| $Y$ | 9300 | 12000 |
| $Z$ | 12000 | 16000 |

Amber Color Bin Limits

| (nm at 20 mA$)$ |  |  |
| :--- | :--- | :--- |
| Bin Name | Min. | Max. |
| 1 | 584.5 | 587.0 |
| 2 | 587.0 | 589.5 |
| 4 | 589.5 | 592.0 |
| 6 | 592.0 | 594.5 |


| Vf Bin Table ${ }^{[2]}$ |  |  |
| :--- | :--- | :--- |
| Bin Name | Min. | Max. |
| VA | 2.0 | 2.2 |
| VB | 2.2 | 2.4 |
| VC | 2.4 | 2.6 |

Tolerance for each bin limit is $\pm 0.05 \mathrm{~V}$.

Tolerance for each bin limit is $\pm 0.5 \mathrm{~nm}$.

Notes:

1. Bin categories are established for classification of products. Products may not be available in all bin categories.
2. Vf Bin table only available for those part number with options $-x x R x x,-x x S x x,-x x-$ Txx, -xxUxx, -xxWxx, -xxYxx.

Tolerance for each bin limit is $\pm 15 \%$.

## Precautions:

## Lead Forming:

- The leads of an LED lamp may be preformed or cut to length prior to insertion and soldering on PC board.
- For better control, it is recommended to use proper tool to precisely form and cut the leads to applicable length rather than doing it manually.
- If manual lead cutting is necessary, cut the leads after the soldering process. The solder connection forms a mechanical ground which prevents mechanical stress due to lead cutting from traveling into LED package. This is highly recommended for hand solder operation, as the excess lead length also acts as small heat sink.


## Soldering and Handling:

- Care must be taken during PCB assembly and soldering process to prevent damage to the LED component.
- LED component may be effectively hand soldered to PCB. However, it is only recommended under unavoidable circumstances such as rework. The closest manual soldering distance of the soldering heat source (soldering iron's tip) to the body is 1.59 mm . Soldering the LED using soldering iron tip closer than 1.59 mm might damage the LED.

- ESD precaution must be properly applied on the soldering station and personnel to prevent ESD damage to the LED component that is ESD sensitive. Do refer to Avago application note AN 1142 for details. The soldering iron used should have grounded tip to ensure electrostatic charge is properly grounded.
- Recommended soldering condition:

|  | Wave <br> Soldering ${ }^{[1,2]}$ | Manual Solder <br> Dipping |
| :--- | :--- | :--- |
| Pre-heat temperature | $105^{\circ} \mathrm{C}$ Max. | - |
| Preheat time | 60 sec Max | - |
| Peak temperature | $250^{\circ} \mathrm{C} \mathrm{Max}$. | $260^{\circ} \mathrm{C}$ Max. |
| Dwell time | $3 \sec$ Max. | $5 \sec$ Max |

Note:

1. Above conditions refers to measurement with thermocouple mounted at the bottom of PCB.
2. It is recommended to use only bottom preheaters in order to reduce thermal stress experienced by LED.

- Wave soldering parameters must be set and maintained according to the recommended temperature and dwell time. Customer is advised to perform daily check on the soldering profile to ensure that it is always conforming to recommended soldering conditions.

Note:

1. PCB with different size and design (component density) will have different heat mass (heat capacity). This might cause a change in temperature experienced by the board if same wave soldering setting is used. So, it is recommended to re-calibrate the soldering profile again before loading a new type of PCB.
2. Avago Technologies' high brightness LED are using high efficiency LED die with single wire bond as shown below. Customer is advised to take extra precaution during wave soldering to ensure that the maximum wave temperature does not exceed $250^{\circ} \mathrm{C}$ and the solder contact time does not exceeding 3 sec . Over-stressing the LED during soldering process might cause premature failure to the LED due to delamination.

## Avago Technologies LED configuration



Note: Electrical connection between bottom surface of LED die and the lead frame is achieved through conductive paste.

- Any alignment fixture that is being applied during wave soldering should be loosely fitted and should not apply weight or force on LED. Non metal material is recommended as it will absorb less heat during wave soldering process.
- At elevated temperature, LED is more susceptible to mechanical stress. Therefore, PCB must allowed to cool down to room temperature prior to handling, which includes removal of alignment fixture or pallet.
- If PCB board contains both through hole (TH) LED and other surface mount components, it is recommended that surface mount components be soldered on the top side of the PCB. If surface mount need to be on the bottom side, these components should be soldered using reflow soldering prior to insertion the TH LED.
- Recommended PC board plated through holes (PTH) size for LED component leads.

| LED component <br> lead size | Diagonal | Plated through <br> hole diameter |
| :--- | :--- | :--- |
| $0.45 \times 0.45 \mathrm{~mm}$ | 0.636 mm | 0.98 to 1.08 mm |
| $(0.018 \times 0.018$ inch $)$ | $(0.025 \mathrm{inch})$ | $(0.039$ to 0.043 inch $)$ |
| $0.50 \times 0.50 \mathrm{~mm}$ | 0.707 mm | 1.05 to 1.15 mm |
| $(0.020 \times 0.020$ inch $)$ | $(0.028$ inch $)$ | $(0.041$ to 0.045 inch $)$ |

- Over-sizing the PTH can lead to twisted LED after clinching. On the other hand under sizing the PTH can cause difficulty inserting the TH LED.

Refer to application note AN5334 for more information about soldering and handling of high brightness TH LED lamps.

Example of Wave Soldering Temperature Profile for TH LED


Ammo Pack Drawing


ALL DIMENSIONS IN MILLIMETERS (INCHES).
NOTE: THE AMMO-PACKS DRAWING IS APPLICABLE FOR PACKAGING OPTION-DD \& -ZZ AND REGARDLESS OF STANDOFF OR NON-STANDOFF.

## Packaging Box for Ammo Packs



NOTE: THE DIMENSION FOR AMMO PACK IS APPLICABLE FOR THE DEVICE WITH STANDOFF AND WITHOUT STANDOFF.

## Packaging Label:

(i) Avago Mother Label: (Available on packaging box of ammo pack and shipping box)

(ii) Avago Baby Label (Only available on bulk packaging)

| AVJGO <br> Lamps Baby Label | RoHS Compliant e3 max temp 250C |
| :---: | :---: |
| (1P) PART \#: Part Number <br> \||||||||||||||||||||||||||||||||||||||||||||||||| |  |
| (1T) LOT \#: Lot Number <br> \|||||| || |||||||||||||||| ||||| || |||||||||||||| |  |
| (9D)MFG DATE: Manufacturing Date \||||||||||||||||||| | QUANTITY: Packing Quantity \|||||| || || ||| |
| C/O: Country of Origin |  |
| Customer P/N: \||||| | CAT: Intensity Bin \||||| |
| Supplier Code: \||||| | BIN: Refer to below information \||||| |
|  | DATECODE: Date Code \| ||||| || || ||||||||| |

## Acronyms and Definition:

BIN:
(i) Color bin only or VF bin only
(Applicable for part number with color bins but without VF bin OR part number with VF bins and no color bin)

OR
(ii) Color bin incorporated with VF Bin
(Applicable for part number that have both color bin and VF bin)

Example:
(i) Color bin only or VF bin only

BIN: 2 (represent color bin 2 only)
BIN: VB (represent VF bin "VB" only)
(ii) Color bin incorporate with VF Bin


VB: VF bin "VB"
2: Color bin 2 only

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[^0]:    Note: Please refer to $A B 5337$ for complete information on part numbering system.

